Semiconductor Equipment and Materials Service

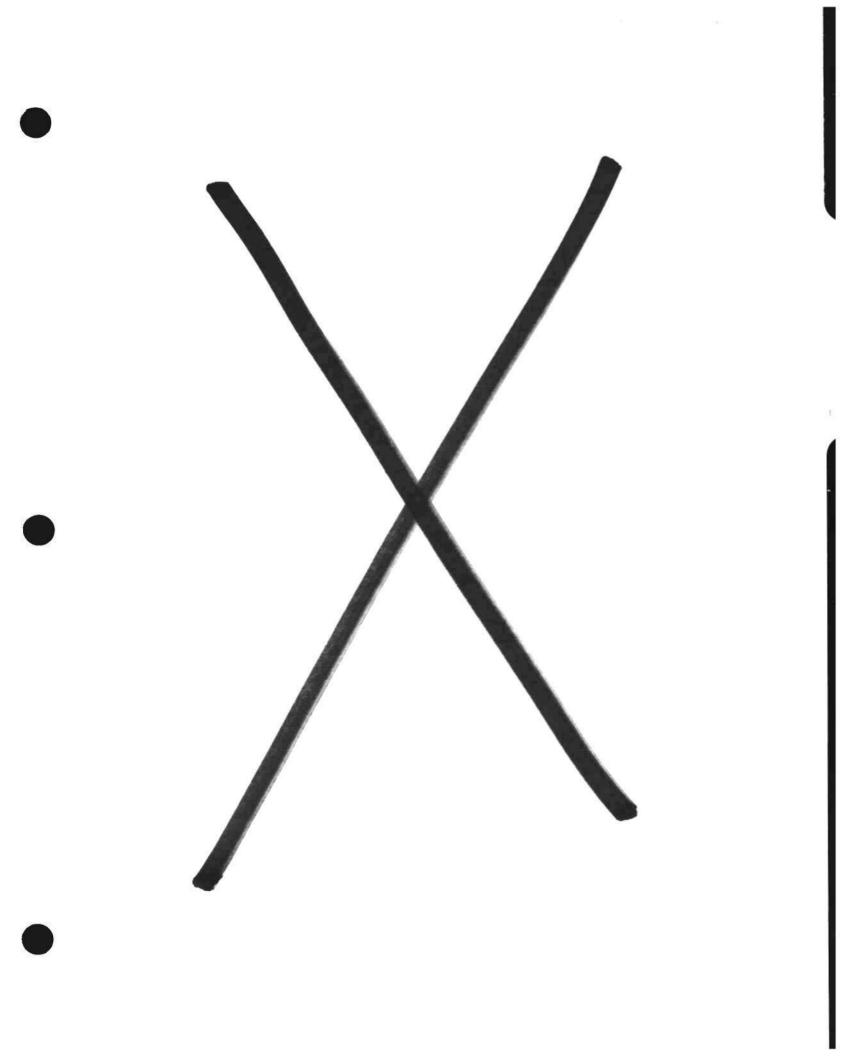
Our Rapidly Changing Industry: Status 1988

PROCEEDINGS AT SEMICON/WEST

Dataquest Incorporated



May 25, 1988 Dunfey San Mateo Hotel





SEMICON/West Seminar May 25 through 25, 1988 San Matee, California

List of Attendees

AG Associates

R. Bruce Springer, Director, Client

Services

ASM International

Herbert Lakens, Marketing Director

ASM Lithography, Inc.

Richard Aurelio, President

David Sikes, General Manager/Executive

Vice President

ATEQ Corporation

Doug Marsh, Vice President, Sales &

Marketing

Advanced Micro Devices, Inc.

Oolep Indreko, Director, Strategic

Technology Planning

C. Richard Deininger, Director,

Manufacturing Technology

Advantest America, Inc.

Frederick Bihler, President

Aeroquip Corporation

Ed Gantzer, Product Manager Tom Smigielski, Market Demand Planner

Air Products & Chemicals, Inc.

Dean Duffy, Program Manager John C. W. King, Group Manager,

Electronics Systems

Airco Electronic Gases

Jeffrey D. Eagles, Manager, Electronic

Business Team

Alan Patricof Associates, Inc.

Bill Bottoms, Senior Vice President &

General Partner

American Semiconductor Equipment Tech. Greg Reyes, President

Anelva Corporation Hideo Mito, General Manager

Apple Computer, Inc. John Jennings, Supply Base Manager,

ASICS

Arthur Young & Company Roger Dunbar, Partner-in-Charge

Alton Page, Audit Principal

Ashland Chemical Company James A. Duquin, Vice President and

General Manager

BTU Engineering Corporation Robert L. Klimm, Vice President,

Marketing

Branson International Lou Perrone, Vice President, Marketing &

Plasma Corporation Technology

CNET Danielle Chalendard, Engineer

Coopers & Lybrand Jon Wellman, General Practice Manager

Cybeq Systems Emile Kerba, Manager, Marketing & Sales

Kanegi Nagai, Executive Vice President/General Manager

Eaton Corporation George Mosnicka, National Sales Manager

Jeoffrey Ryding, Vice President & Director

Marketing, Sales & Services Robert Semmler, General Manager Walter Wriggins, Director, Marketing

E.I. DuPont de Nemours & Company Daniel J. Kratzer, Marketing Programs

. Manager

EKC Technology, Inc. Joyce M. Jensch, National Sales Manager

Electronic News

Jeff Dorsh

Electronic Engineering Times

Loring Wirbel, Editor

ENI

Edward L. Maier, Director, Business Planning

Equitable Life Leasing Co.

Steve Grundon, Vice President Marketing Services & Development Ellie Sanchez, Market Research Analyst

FSI International

Leena R. Orpo, Communications Specialist Mary Jo Peters, Coordinator Public Relations

First Interstate Bank

Rose Marie Filicetti, Vice President Marc J. Verissimo, Vice President

Focus Semiconductor Systems, Inc.

Jerry Oberly, Vice President, Sales & Marketing

GaSonics

Phil Crabtree, Marketing Manager

Genus, Inc.

Ron Dornseif, Director, Strategic Programs William W.R. Elder, President and CEO Richard Hannigan, Executive Vice President and CFO Michael W. McCann, Director, Product Marketing Paul Reagan, Executive Vice President and COO

Genus/Ionex

Frank Deak, Vice President, General Manager Manny Sieradzki, Vice President, Marketing Norm Turner, Chief Scientist

Gould. Inc.

Joe O'Neill, Vice President, Sales

Hampshire Instruments, Inc. Tom Kulczycki, Director, Sales & Marketing Hevlett-Packard Company Clint Hutchinson. Sales Manager Hitachi America, Ltd. K. Ueno, Senior Vice President Gamil Chelico, Manager, Strategic & Honeywell Microswitch Business Development Gary Tighe, Product Planner Honeywell, Inc. Larry Goldstein, Staff Engineer Eugene R. Hnatek, R & D Engineering Manager Hualon Microelectronics Corporation Yi-Jia Chen, Equipment Department Manager C. S. Peng Liank Wu, Product Engineering Department Manager Hughes Aircraft Company Carl Salanitro, Manager, Corporate Materials Hyundai Electronics America Iksu Kim, Director, Strategic Marketing ICD Austria Hubert Gammer, Director IHI Yukiya Nakagawa IVS, Inc. Chris Morrill, Vice President, Sales & Marketing Insystems, Inc. George Canavan, Vice President, Marketing

Manager

Amy Habib, Market Analyst

Sarah Robinson, Research Analyst

Jacques J. Vuye, International Marketing

Intel Corporation

Keithley Instruments, Inc.	John Snyder, Senior Market Research Analyst
Kobe Development Corporation	Katsuhiko Inoue, Manager
L'Air Liquide	Gilles Moutardier, Engineer
Lam Research Corporation	Steve P. DeOrnellas, Vice President, Marketing Henk Evenhuis, Vice President-Finance & Administration, Chief Financial Officer
Liquid Air Corporation Alphagaz	Susan Schmertmann, Product Manager
Lucky Advanced Materials, Inc.	J. S. Choo, Senior Managing Director S. K. Hahn, President
Microelectronics Technology Company	Kazu Funahashi Akira Miura, President & General Manager Akifumi Nagao
Mitsubishi International Corp.	Raymond Phillips, Senior Vice President, Operations
Mitsubishi Metal Corporation	Kikuo Matsumoto, General Manager, New Materials Division
Monsanto Electronic Materials Company	Wendy Grossman, Manager, Market Analysis
Morton Thiokol, Inc.	Jim E. Dodsworth, Product Manager, Semiconductor Materials Group
NBK Corporation	Donna Felter, Vice President, Marketing

NEC Corporation

and Sales

Kazuhiko Tsukada, Supervisor, Semiconductor Group Planning

Napson, Ltd. Makoto Nakamura, Marketing Manager Niigata MTI Company, Ltd. Manoru Shibata. Vice President Masaharu Takeda, Sales Manager Chris Brandmaier, Assistant Manager, Nikon Inc. Industrial Section, Technological Department Nikon Precision, Inc. Rick La France, Director, Marketing Northern Telecom Electronics Inc. Valerie Kisak, Manager, Industry Economics Orient Semiconductor Electronics, Ltd. David Cheng, Vice President Mike Solomon, General Manager Osaka Sanso Kogyo, Ltd. Perkin-Elmer Corporation Robert McMenamin, Western Regional Marketing Manager PlanTek Larry Campbell, Senior Vice President Prometrix Corporation Paul Covec, Director, Marketing Talat Hasan, Vice President, Advanced Products Steve Westrate, International Marketing Manager Jonathan Baer, Investment Manager R&D Funding Corporation Lawrence Bill, Vice President Richard E. Moser, President RCM Capital Management Huachen Chen, Research Analyst Ross-Dove Company, Inc. Bruce W. Leister, National Account Executive

SEH America, Inc.	Isao Iwashita, President
SGS-Thomson Microelectronics	Mike J. VanHoy, Vice President, Manufacturing Operations
Security Pacific Capital Corporation	James McElwee, Managing Partner
Seiko Instruments USA, Inc.	Hiroshi Fukino, President
Semiconductor Services	Carol Seaborn
Semiconductor Systems, Inc.	Jim Knudsen, Vice President, Engineering
Shinko Electric America, Inc.	David Mehlhoff, Marketing Manager
Sieber Kikai	Yasuo Komatsuzaki, Assistant Manager
Siemens Components, Inc.	Peter Leditznig, Vice President, Controller
SiSCAN Systems	Gerry Leever, Marketing Manager
Sigma Partners	Cliff Haas, Associate
Silicon Valley Group, Inc.	Jim Herlinger, Vice President & General Manager CVD Operations
Siliconix Incorporated	Joe Baranowski, I.C. Marketing Manager
Siltec Corporation	Stanley Myers, President & CEO
Siltec Silicon	Larry Hydrusko, Marketing Manager Dennis West, Vice President, Marketing & Sales

Solid State Technology Magazine Sid Marshall, Editor Taiwan Semiconductor Mfg. Co. Klaus C. Wiemer, Vice President, Operations Team International Ltd. Gene J. Amato, President, CEO Tegal Corporation George Gorin, Vice President Craig Keith, Comptroller Corey J. Mullins, Marketing Manager Tencor Instruments Dale Guidoux Daniel Tam Thesis Group Jim Stewart, Vice President Clay Sutton, President Klaus Schuegraf, Vice President Tylan Corporation Ultratech Stepper, Inc. Ken Agarwal, Director, Marketing Union Carbide Corporation Charles Krichbaum, Marketing Manager, **Bulk Gases** Union Carbide Corporation Thomas Nelson, Applications Manager, Electronics Thomas L. Singman, Marketing Manager, Electronics Walter Willett, National Sales Manager VLSI Technology, Inc. Ken Chuang Vic Kulkarni Wacker Siltronic Corporation David H. Ward, Manager, Regional Sales Western Digital Corporation John V. Crosby, Vice President, LSI

Manufacturing

Westpac Banking Corporation

Carol A. Howe, International Banking

Officer

William S. Reed, Vice President

Xilinx

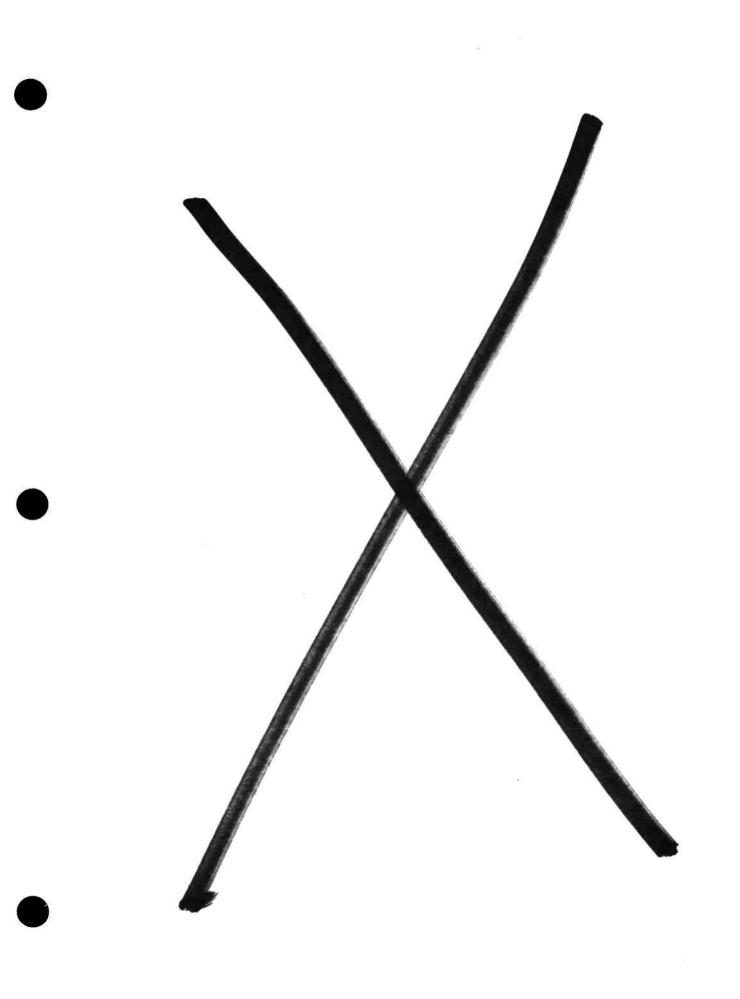
Frank Myers, Vice President,

Manufacturing

Xynetics

Gordon C. Westwood, Vice President,

Marketing





SEMICON/WEST SEMINAR

Our Rapidly Changing Industry: Status 1988

Agenda

Semiconductor Equipment and Materials Service May 25, 1988 Dunfey San Mateo Hotel

7:30 a.m. Registration and Continental Breakfast

8:00 a.m. Welcome and Introduction

Robert McGeary

Director

Semiconductor Equipment and Materials Service

Dataquest Incorporated

8:15 a.m. Keeping an Eye on the Customer's Customer

Anthea Stratigos Associate Director

Semiconductor User and Applications Group

Dataquest Incorporated

8:40 a.m. Semiconductor Manufacturing Comes of Age

George Burns Industry Analyst

Semiconductor Equipment and Materials Service

Dataquest Incorporated

9:05 a.m. Capacity Analysis in North America

Mark Reagan Research Analyst

Semiconductor Equipment and Materials Service

Dataquest Incorporated

9:30 a.m. The Changing Structure of the Worldwide Fab Equipment Industry

Joseph Grenier

Senior Industry Analyst

Semiconductor Equipment and Materials Service

Dataquest Incorporated

9:55 a.m. Coffee Break

10:15 a.m. Semiconductor Materials: Perspective on Wafers

Dr. Peggy Marie Wood

Industry Analyst

Semiconductor Equipment and Materials Service

Dataquest Incorporated

10:40 a.m. World Semiconductor Outlook

Gene Norrett

Corporate Vice President and Division General Manager

Components Division Dataquest Incorporated

11:05 a.m. Competitive Structure in Asia

Tom Wang Director

Asia/Pacific Components Group

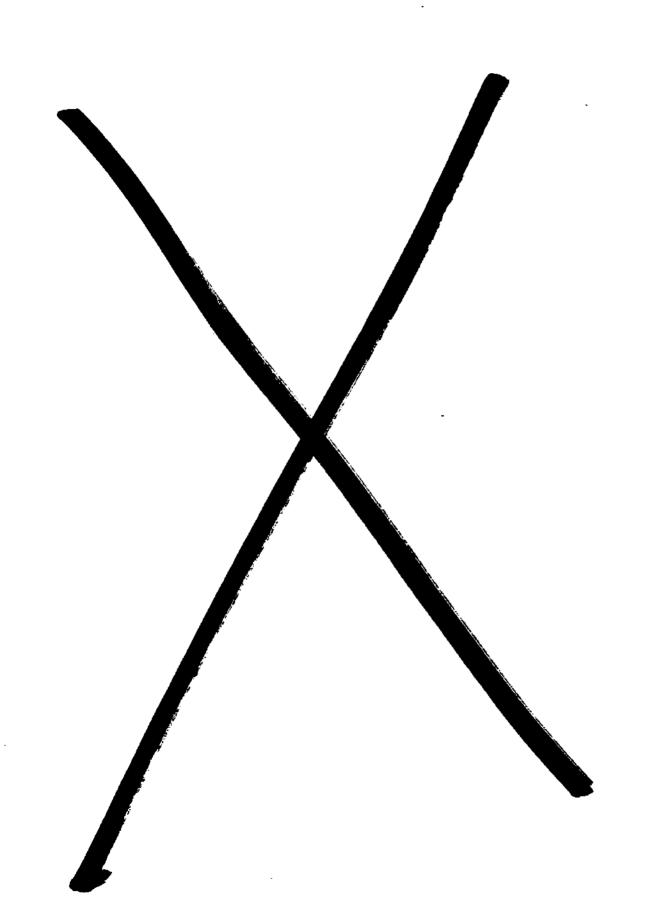
Dataquest Incorporated

11:30 a.m. European Competitiveness Analysis

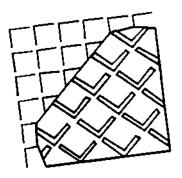
Bipin Parmar

Senior Industry Analyst European Components Group Dataquest Incorporated

12:00 Noon Adjourn



Our Rapidly Changing Industry: Status 1988



SEMICONDUCTOR INDUSTRY STATUS -- 1988

ROBERT McGEARY

Director
Semiconductor Equipment and Materials Service
Dataquest Incorporated

SEMINAR AGENDA

Time	Speaker	Subject
8:00 a.m.	Robert McGeary	Welcome
8:15 a.m.	Anthea Stratigos	The Customer
8:40 a.m.	George Burns	Semiconductor Manufacturing
9:05 a.m.	Mark Reagan	Capacity Analysis
9:30 a.m.	Joe Grenier	Changing Structure of Equipment Markets
9:55 a.m.	Break	•
10:15 a.m.	Peggy Wood	Perspective on Silicon
10:40 a.m.	Gene Norrett	World Outlook
11:05 a.m.	Tom Wang	Asian Outlook
11:30 a.m.	To Be Announced	European Outlook

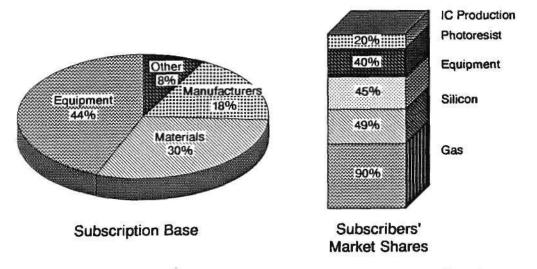
SEMS ACCOMPLISHMENTS

Founded May 1985

- Leading market research service for semiconductor equipment and materials
- Developed worldwide fabrication data base
- Developed comprehensive equipment vendor data base
- Developed worldwide data base on silicon production and consumption

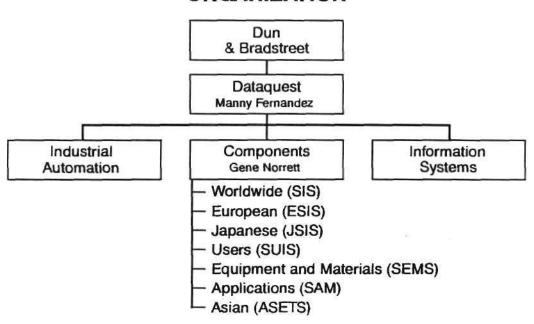
SEMS CLIENTS

Profile



Source: Dataquest

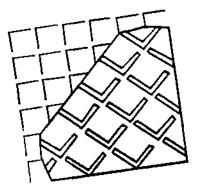
DATAQUEST COMPONENTS DIVISION ORGANIZATION



Dataquest

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KEEPING AN EYE ON THE CUSTOMER'S CUSTOMER

ANTHEA C. STRATIGOS

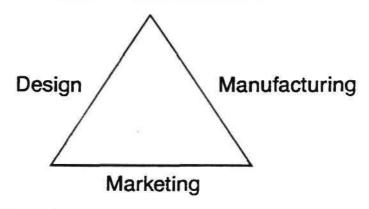
Associate Director
Semiconductor User and Applications Group
Dataquest Incorporated

You must either conquer and rule or serve and lose,
Suffer or triumph,
be the anvil or the hammer.

Goethe

. . . But remember, you haven't lost until you've surrendered.

BECOMING THE BEST

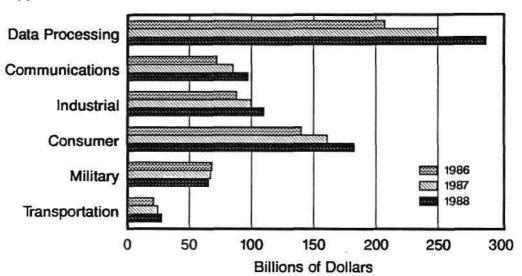


- Keep listening to the customer
- · Keep your eyes on the customer's customer



WORLDWIDE ELECTRONICS PRODUCTION

Application Market

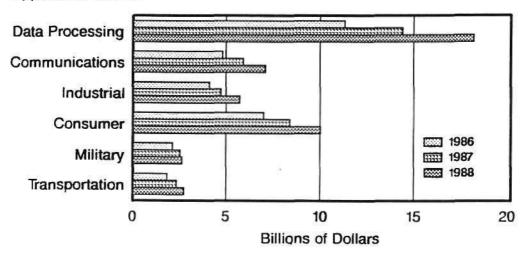


Source: Dataquest

WORLDWIDE SEMICONDUCTOR CONSUMPTION

By Application Market

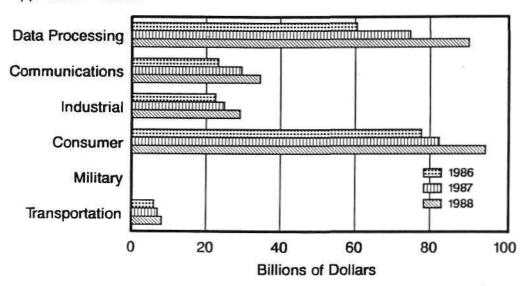
Application Market



Source: Dataquest

JAPANESE ELECTRONICS PRODUCTION

Application Market

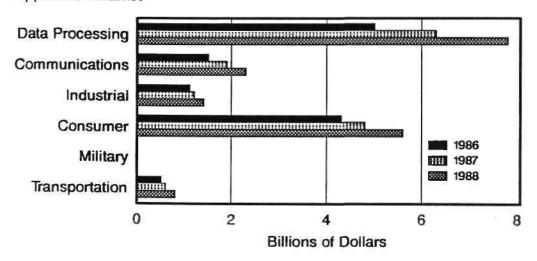


Source: Dataquest

JAPANESE SEMICONDUCTOR CONSUMPTION

By Application Market

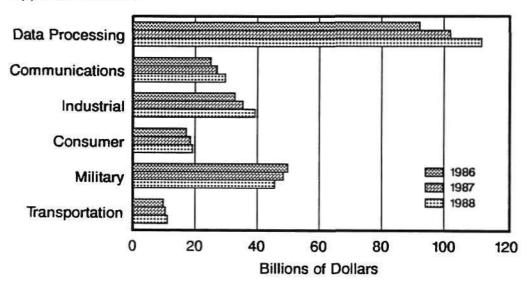
Application Market



Source: Dataquest

NORTH AMERICAN ELECTRONICS PRODUCTION

Application Market

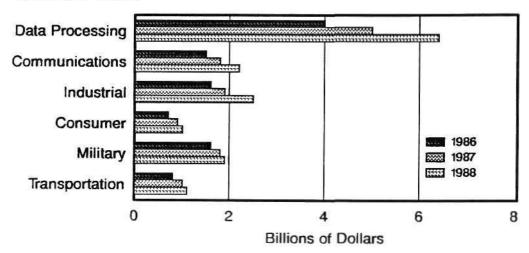


Source: Dataquest

NORTH AMERICAN SEMICONDUCTOR CONSUMPTION

By Application Market

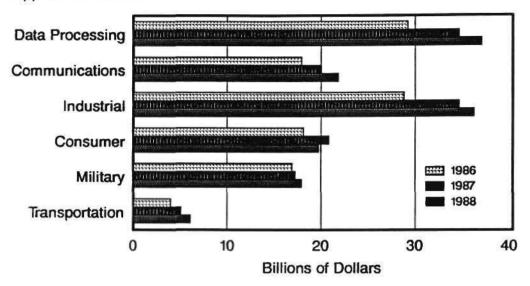
Application Market



Source: Dataquest

EUROPEAN ELECTRONICS PRODUCTION

Application Market

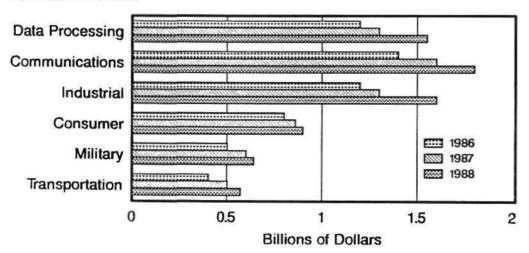


Source: Dataquest

EUROPEAN SEMICONDUCTOR CONSUMPTION

By Application Market

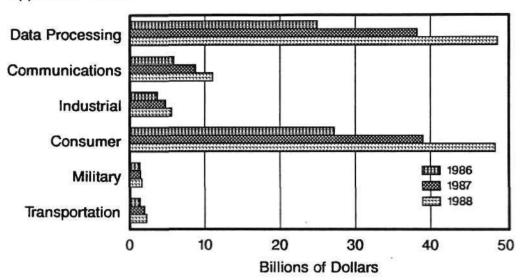
Application Market



Source: Dataquest

REST OF WORLD ELECTRONICS PRODUCTION

Application Market

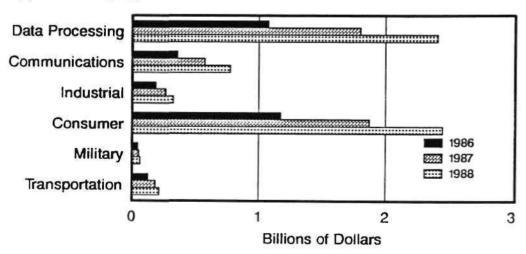


Source: Dataquest

REST OF WORLD SEMICONDUCTOR CONSUMPTION

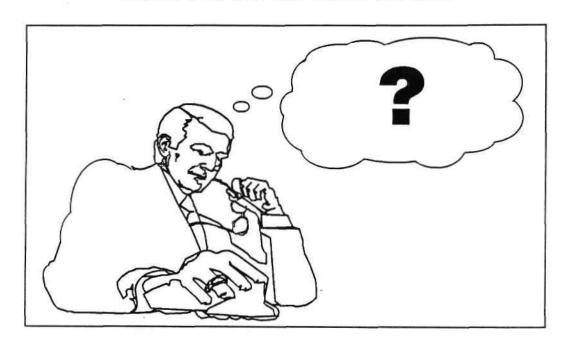
By Application Market

Application Market

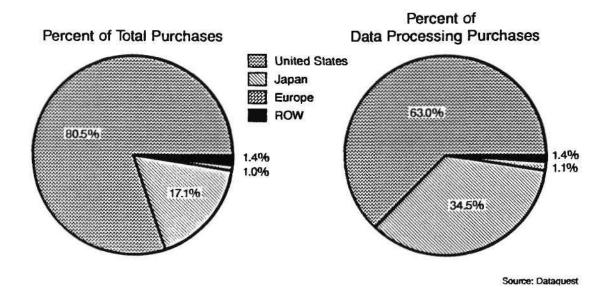


Source: Dataquest

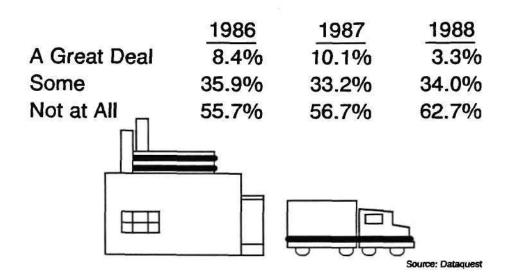
SEMICONDUCTOR USER ISSUES



REGIONAL SUPPLIER BASE

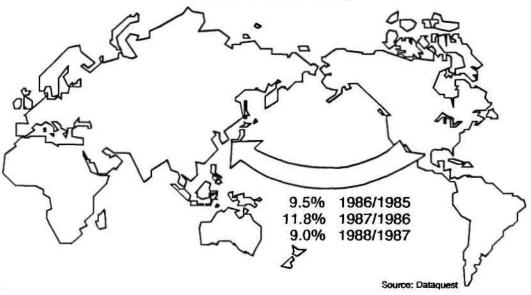


ANTICIPATED SHIFT TO OFFSHORE PRODUCTION



ESTIMATED U.S. SEMICONDUCTOR CONSUMPTION MOVING OFFSHORE

(Percent of Total Dollars)



THE MAJOR ISSUES

1986

Pricing
Quality/reliability
On-time delivery
Supply/availability/shortages
JIT/inventory control
Reducing vendor base
Product obsolescence
Second-sourcing
Forecasting

1987

Pricing
Availability/lead times
Quality/reliability
On-time delivery
FMVs/trade agreement
Cost control
JIT/inventory control
Surface mount
New products/obsolescence
ASICs
Offshore manufacturing
and procurement

THE MAJOR ISSUES

1988

- Availability/lead times/shortages
- Pricing
- On-time delivery
- Cost control
- Memories
- Quality/reliability
- Reducing vendor base
- New products/obsolescence
- JIT/inventory control
- Fluctuating yen/currency exchange

CONCLUSIONS

- Users expect continued growth in purchases
- Availability, lead times, and shortages are critical issues
- Closer vendor/buyer connections may temper the cycle
- The shift offshore may be slowing
- Cost control and manufacturing strategies still play critical roles in determining buyer action

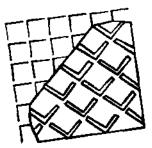
WORKING PARTNERSHIPS ARE CRUCIAL

- Users need to:
 - Protect market
 - Access technology
 - Control costs

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SEMICONDUCTOR MANUFACTURING COMES OF AGE

MEETING THE CHALLENGES OF INCREASING COST AND COMPLEXITY

GEORGE BURNS

Industry Analyst
Semiconductor Equipment and Materials Service
Dataquest Incorporated

1987 U.S. CAPACITY UTILIZATION BY LINE GEOMETRY

Line Geometry

< 3 Micron 0.87 > = 3 Micron 0.67

Source: Dataquest

NEW U.S. FABS

<u>State</u>	Number of Fabs
California	. 20
Texas	17
New Mexico	3
Oregon	3
Arizona	3
Colorado	3
Maine	3
Others	14
Total	66

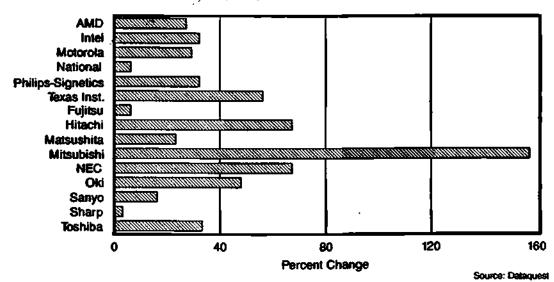
Source: Dataquest

SEMICONDUCTOR MANUFACTURING COMES OF AGE

- Semiconductor demand at the leading edge
- Capital spending surging forward
- Industry-wide response increasing productivity
 - Equipment productivity
 - Culture
 - Cleanliness

U.S. AND JAPANESE COMPANIES PERCENTAGE INCREASE

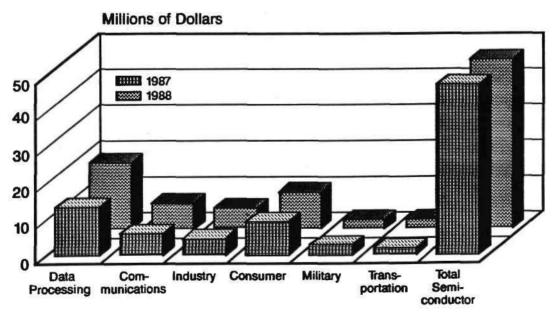
Happy Days Are Here Again?



SEMICONDUCTOR MANUFACTURING COMES OF AGE

- Semiconductor demand at the leading edge
- Capital spending surging forward
- Industry-wide response increasing productivity
 - Equipment productivity
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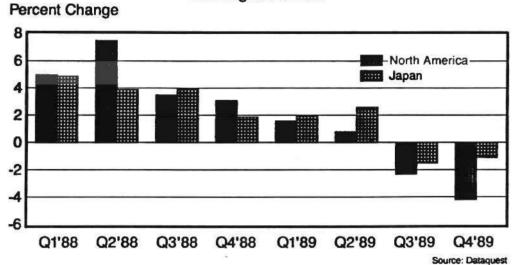
SEMICONDUCTOR APPLICATION MARKET REVENUE



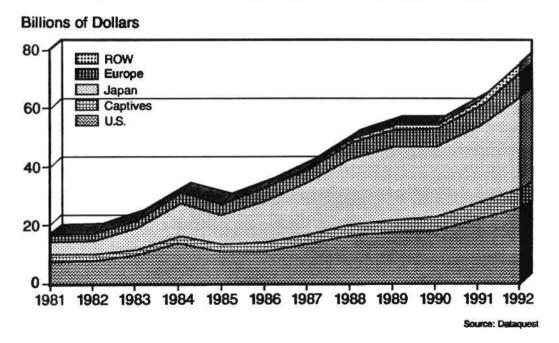
Source: Dataquest

ESTIMATED WORLDWIDE SEMICONDUCTOR MARKET

Charting the Course



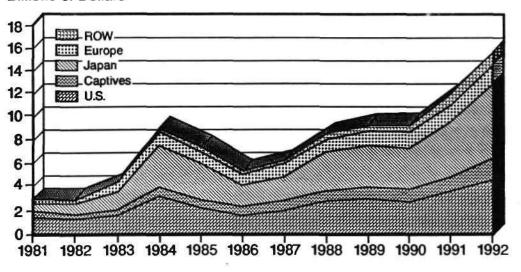
ESTIMATED SEMICONDUCTOR PRODUCTION



CAPITAL SPENDING

The Chip Cornucopia

Billions of Dollars



Source: Dataquest

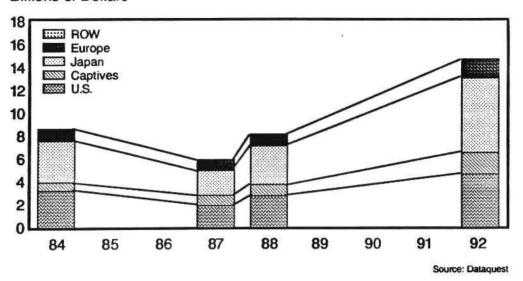
PERCENTAGE CHANGE IN CAPITAL SPENDING BY REGION

	1984	1985	1986	1987	1988	1989	1990	1991	1992
North America	108%	(34%)	(26%)	24%	45%	5%	(10%)	27%	36%
Japan	116%	(12%)	(45%)	22%	58%	7%	(1%)	35%	35%
Europe	93%	(18%)	9%	1%	8%	8%	10%	20%	15%
ROW	245%	1%	(38%)	30%	27%	20%	35%	30%	20%
Captive	52%	10%	0%	10%	9%	14%	12%	21%	27%
Worldwide									
Production	107%	(18%)	(28%)	17%	38%	8%	1%	29%	31%

Source: Dataquest

THE EBBS AND FLOWS OF CAPITAL SPENDING

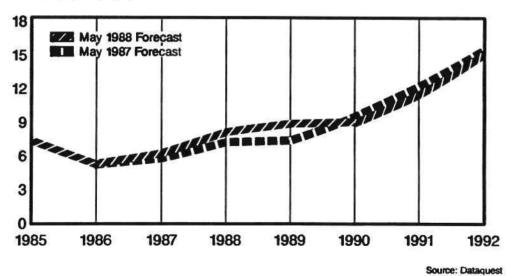
Billions of Dollars



FORECAST COMPARISON

Forecast 1987 vs. Forecast 1988

Millions of Dollars

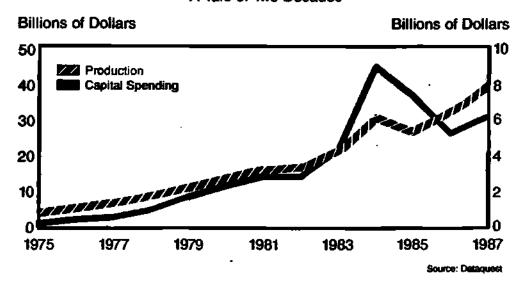


SEMICONDUCTOR MANUFACTURING COMES OF AGE

- Semiconductor demand at the leading edge
- · Capital spending surging forward
- Industry-wide response increasing productivity
 - Equipment productivity
 - Culture
 - Cleanliness

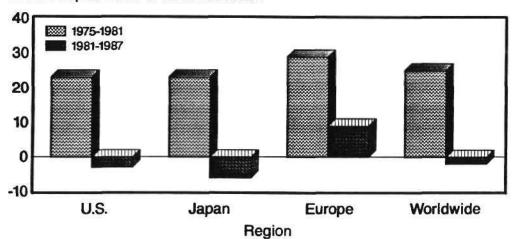
GROWTH OF CAPITAL SPENDING AND PRODUCTION

A Tale of Two Decades



DIFFERENCE: CAGR OF CAPITAL AND PRODUCTION SIGNS OF INCREASING PRODUCTIVITY

CAGR Capital Less CAGR Production

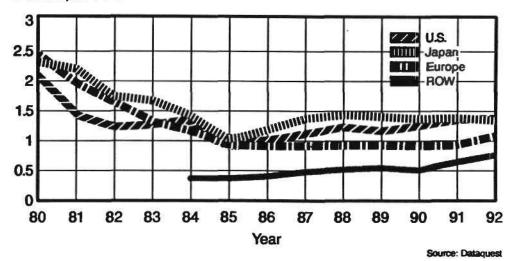


Source: Dataquest

REVENUE/PPE

The Productivity of Capital





REVENUE/PPE

The Productivity of Capital

 $Rev./PPE = In.^2/PPE \times Rev./In.^2$

Where PPE = property, plant, and equipment and In.2/PPE = equipment productivity and Rev./In.2 = process productivity

Source: Dataquest

REVENUE PER SQUARE INCH

The Productivity of Silicon

- Rev./in.2 = f (yield, ASP, 1/(die size))
- Yield is increasing:
 - Automation
 - Cleanliness
 - Manufacturing culture
- Die size and ASP balance each other

Source: Dataquest

EQUIPMENT PRODUCTIVITY

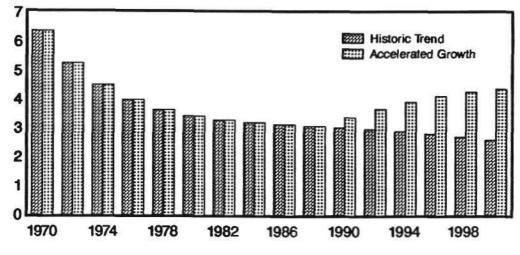
In.2/PPE = f (reliability, utilization, throughput)

- Reliability
 - Industry average is close to 90%
- Utilization
 - Industry average is less than 40%
 - Commodity products have high utilization
 - Multiproduct fabs are trying to increase by use of CIM
- Throughput
 - Movement from batch to single-wafer processing
 - Movement to larger wafer sizes
 - Net effect is that throughput is increasing
- PPE
 - ASPs are increasing

Source: Dataquest

ESTIMATED EQUIPMENT PRODUCTIVITY MODEL

Silicon Area per Dollar of PPE



Source: Dataquest

SEMICONDUCTOR MANUFACTURING

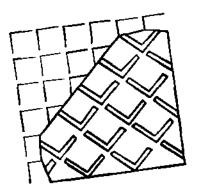
Summary and Conclusion

- Semiconductor demand will increase
 - Especially at the leading edge
- Capital spending will grow at a healthy rate
- Capital productivity will continue to increase
- Manufacturing technology is a competitive advantage

Source: Dataquest

Dataquest

a company of The Dun & Bradstreet Corporation Our Rapidly Changing Industry: Status 1988



CAPACITY ANALYSIS IN NORTH AMERICA

MARK REAGAN

Research Analyst
Semiconductor Equipment and Materials Service
Dataquest Incorporated

AGENDA

- Description of the fab data base
- Capacity utilization by technology
- Fab lines by wafer size
- Profile of new fab lines 1985-1990s

AGENDA

• Description of the fab data base

DATA FIELDS

- Company name
- Location
- Fab name
- Clean room size
- Clean room class
- Wafer size
- Average mask levels

- Wafer start capacity
- Actual wafer starts
- Test and blank wafers used
- R&D wafer starts
- Minimum linewidth
- Shifts per day
- Days per week

DATA FIELDS

- Type of fab line
- Turnaround time
- Machine operators
- Line yields
- Origin of ownership
- Percent positive resist

- Products produced
- Technology used
- Book value of equipment
- Installed equipment
- Average die size
- Factory-level software

PRODUCTS

- Memories
- Micros
- Standard logic
- ASICs

- Analog
- Discretes
- Opto
- Power ICs

TECHNOLOGIES

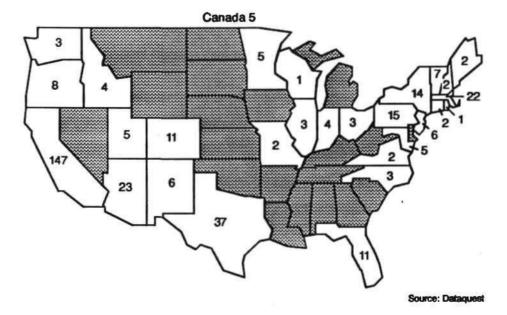
- CMOS
- Bipolar
- NMOS/PMOS
- GaAs/other III/Vs
- BICMOS

DATA SOURCES

- Annual phone survey
- Confidential industry sources
- Fab tours
- Component group analysts (San Jose)
- Dataquest analysts in Tokyo, London, Seoul
- Scanning more than 30 semiconductor periodicals

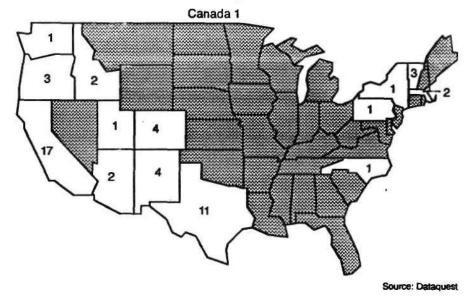
NUMBER OF FAB LINES INSTALLED

Includes Fabs Going into Production During 1988 and GaAs Lines; Excludes R&D Lines



FAB LINES INTO PRODUCTION DURING 1989 AND BEYOND

Includes GaAs Lines; Excludes R&D Lines



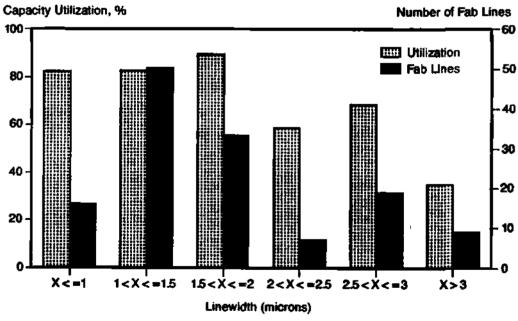
FAB DATA BASE CONTENTS

- 309 silicon fab lines
- 50 GaAs fab lines
- 76 R&D lines
- 53 fabs going into production after 1988
- 151 foundry relationships
- 76 foundry users

AGENDA

- Description of the fab data base
- Capacity utilization by technology

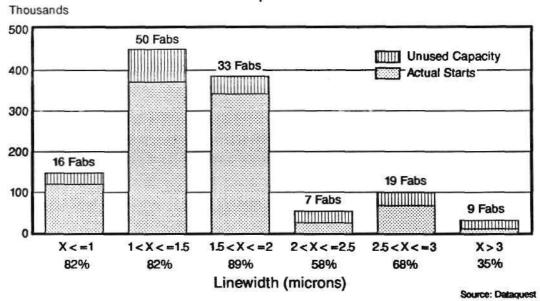
CMOS Q4 1987



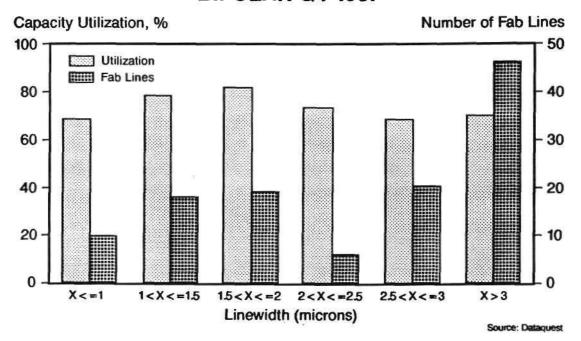
Source: Dataquest

CMOS Q4 1987

Wafer Starts per Four Weeks

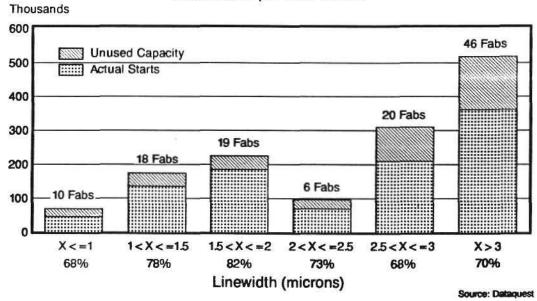


BIPOLAR Q4 1987



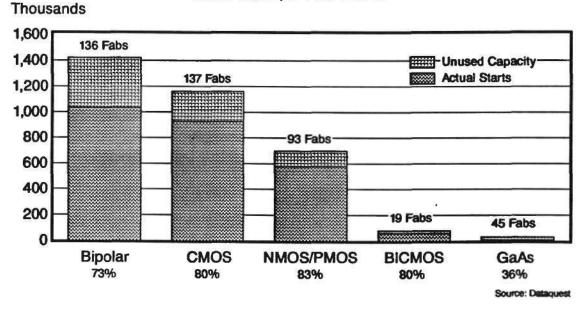
BIPOLAR Q4 1987

Wafer Starts per Four Weeks



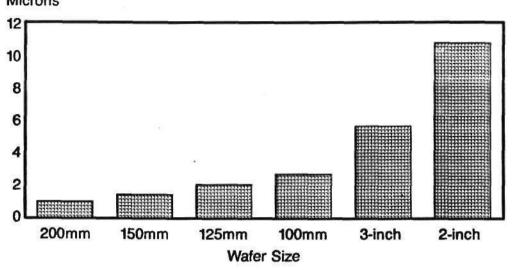
NORTH AMERICA Q4 1987

Wafer Starts per Four Weeks



AVERAGE LINEWIDTH BY WAFER SIZE

Average Linewidth (Drawn)
Microns



Source: Dataquest

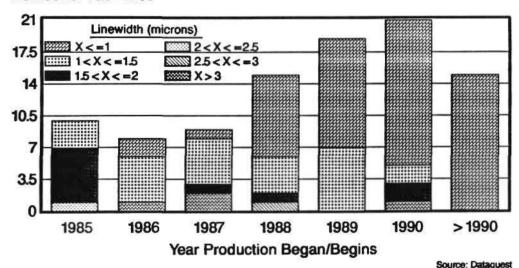
AGENDA

- · Description of the fab data base
- Capacity utilization by technology
- Fab lines by wafer size
- Profile of new fab lines 1985-1990s

NEW SILICON PILOT AND FAB LINES

Actual and Announced

Number of Fab Lines



William Way and the Carl A Carl A

CONCLUSIONS

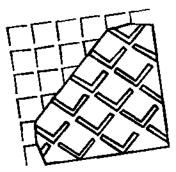
- Majority of fabs running 4-inch wafers
- 6-inch technology has a long way to go
- Broad-based 8-inch production a long way off
- Vast majority of new fabs will be sub-1.6 micron, 6-inch, CMOS lines
- Utilization is highest in 1.1-2 micron range but a lot of capacity will be coming up

Source: Dataquest

Dataquest

a company of The Dun & Bradstreet Corporation

Our Rapidly Changing Industry: Status 1988



THE CHANGING STRUCTURE OF THE WORLDWIDE FAB EQUIPMENT INDUSTRY

JOSEPH GRENIER

Senior Industry Analyst
Semiconductor Equipment and Materials Service
Dataquest Incorporated

SEMI MEMBERSHIP

Total Membership	1,082
U.S. Company Membership Percent Private Financial Size (\$M)	889 71%
0 to \$5 \$5 to \$10 \$10 to \$25 \$25 to \$50 \$50 to \$100 \$100 +	60% 15 14 6 3 2
	100% Source: SEMI

FAB EQUIPMENT MARKET -- 1986

(Millions of Dollars)

Lithography
Track Equipment
Dry Etch/Strip
Deposition
Diffusion/RTP
Ion Implantation
CD/Wafer Inspection

Total 117 Companies	\$2,029
Other Equipment	569
Total Fab Equipment Market	\$2,598
	Source: Dataquest

FAB EQUIPMENT COMPANIES

1986 Revenue

Revenue (\$M)	Number of Companies	Percent
0 to \$5	59	50%
\$5 to \$10	14	12
\$10 to \$25	21	18
\$25 to \$50	12	10
\$50 to \$100	7	6
\$100 to \$200	3	3
\$200 +	1	1
	117	100%

Source: Dataqueet

FAB EQUIPMENT COMPANIES

1986 Rankings

Companies by Rank	Revenue (\$M)	Percent
1-10	\$1,046	52%
11-20	385	19
21-30	214	10
31-103	384	19
	\$2,029	100%
		Source: Dataquest

FAB EQUIPMENT COMPANIES

Top Ten	
(Millions of Dollars)	

	(mmono.	or Bonaro,		
1982 Rank	-	1986 Rank		
Perkin-Elmer	\$152	Perkin-Elmer	\$220	
Varian	89	Canon	141	
Applied Materials	69	Applied Materials	125	
GCA	64	Varian	115	
Canon	60	Nikon	93	
Eaton	56	GCA	86	
Kokusai	43	General Signal	75	
Thermco	33	Ulvac	71	
General Signal	32	Eaton	61	
Nikon	32	TEL Thermco	59	
U.S. Companies	79%	U.S. Companies	65%	
Japanese Companies	21%	Japanese Companies	35%	

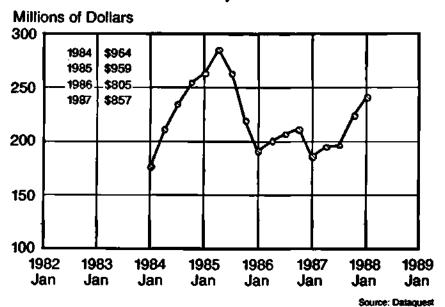
Source: Dataquest

TEN-COMPANY INDEX

- Applied Materials
- KLA
- Lam Research
- Machine Technology
- Materials Research
- Nanometrics
- Optical Specialties
- Perkin-Elmer
- Silicon Valley Group
- Varian

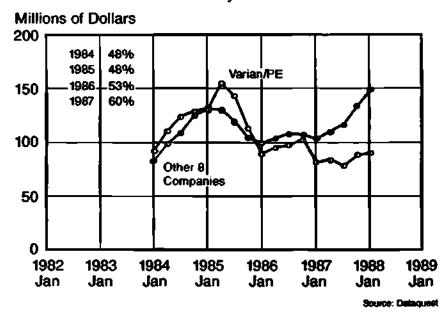
TEN-COMPANY INDEX

Quarterly Sales



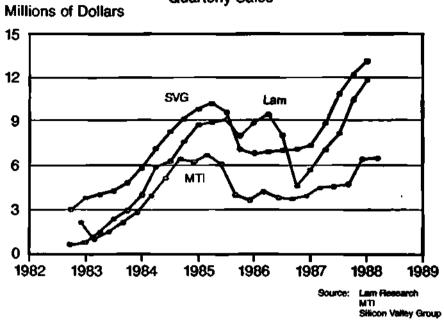
TEN-COMPANY INDEX

Quarterly Sales



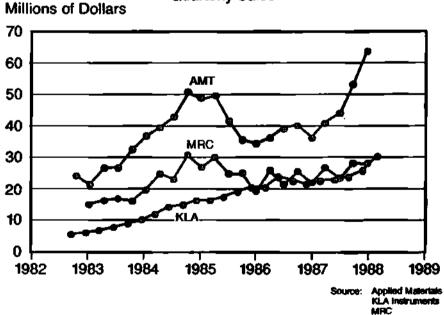
LAM, MTI, AND SVG

Quarterly Sales



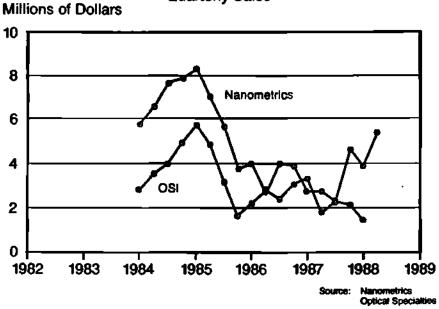
AMT, KLA, AND MRC

Quarterly Sales



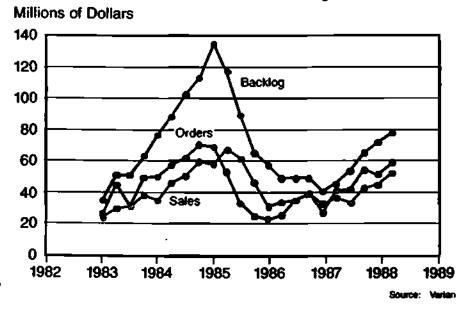
NANOMETRICS AND OSI

Quarterly Sales



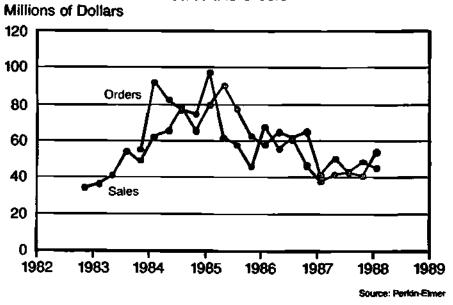
VARIAN

Sales, Orders, and Backlog



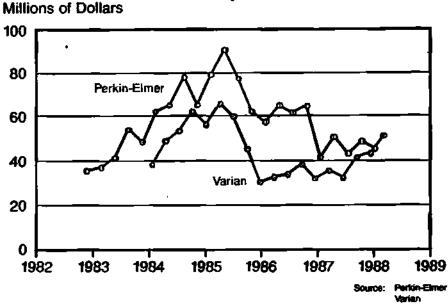
PERKIN-ELMER

Sales and Orders



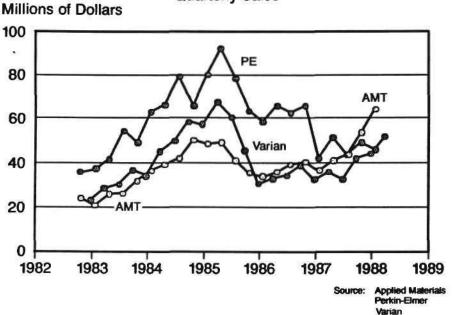
PE AND VARIAN

Quarterly Sales



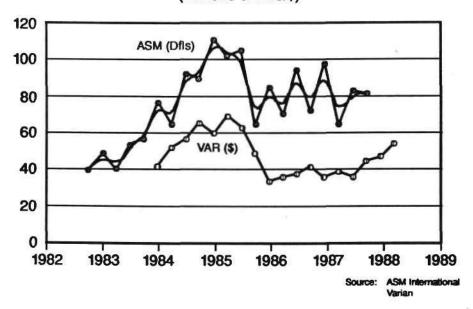
AMT, PE, AND VARIAN

Quarterly Sales



ASM AND VARIAN

Quarterly Sales (Millions of Dfls/\$)



ASM INTERNATIONAL

Quarterly Sales and Income (Millions of Dfls) Sales **Net Income** 120 30 Sales 100 20 80 10 60 0 40 -10 Net Income 20 -20 0 -30 1982 1983 1984 1985 1986 1987 1988 1989 Source: ASM

SEMICON/JAPAN EXHIBITORS BY COUNTRY

	1982	1983	1987
Japan	232	327	542
United States	204	289	274
United Kingdom	11	15	21
West Germany	12	14	11
Other	16	30	27
Total	47 5	675	875

Source: SEMI

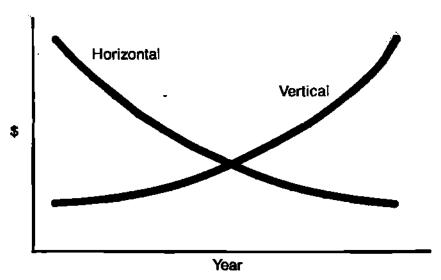
ADVANCED EQUIPMENT TECHNOLOGY BEING DEVELOPED BY THE JAPANESE

- Photo CVD
- Excimer lasers
- Ion beam technology
- Large-substrate processing equipment
- Vertical furnaces
- ECR equipment

Source: Dataquest

DIFFUSION FURNACE MARKET

Trends



Source: Dataquest

JAPANESE VERTICAL FURNACES

	Diffus	ion	LPCVD		
ASM Japan	VDF-100	(Y35M)	VMP-100	(Y45M)	
Dainippon Screen	DSF		?		
Denko Systems	SD (1)	(Y35M)	SC (1)	(Y45M)	
	SD (2)	(Y60M)	TC (2)	(Y80M)	
Disco	DWD 1000	(Y150M)	DWL 1000		
Koyo Lindberg	VFS-4000	(Y30M)	VFS-4001/7		
Kokusai	DD-802V	(Y44M)	DJ-802V	(Y55M)	
TEL Sagami	VCF-610		VDF-610		
Ulvac-BTU	L2	(Y60M)	?		

Source: Dataquest

WORLDWIDE ECR ACTIVITY

Japanese	Companies	European	Cor

Anelva Ashida Elionix Hitachi Japan Steel Works Shimadzu Sumitomo Metal Tokki Tokyo Ohka

European Companies

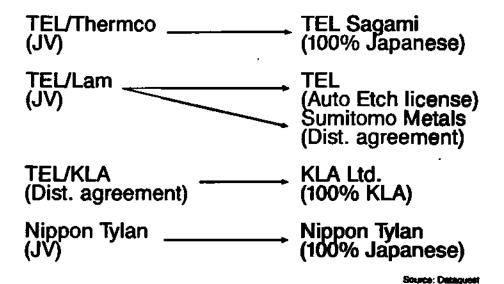
E.T. Electrotech Plasma Technology

U.S. Companies

Lam Research (marketing agreement) Materials Research (licensing agreement) Veeco (source only)

Source: Dataquest

CHANGES IN JAPANESE ALLIANCES

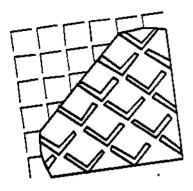


SUMMARY

- Structure of worldwide fab equipment industry is evolving.
- Previous leaders in U.S. fab equipment industry are losing momentum.
- Japanese equipment industry is maturing.
- The future? -- Only the excellent will survive.

Source: Dataquest

Dataquest am acompany of Our Rapidly Changing Industry: Status 1988



SEMICONDUCTOR MATERIALS: PERSPECTIVE ON WAFERS

PEGGY MARIE WOOD, Ph.D.

Industry Analyst
Semiconductor Equipment and Materials Service
Dataquest Incorporated

BACK TO THE ELEMENTS

A Look At The Periodic Table

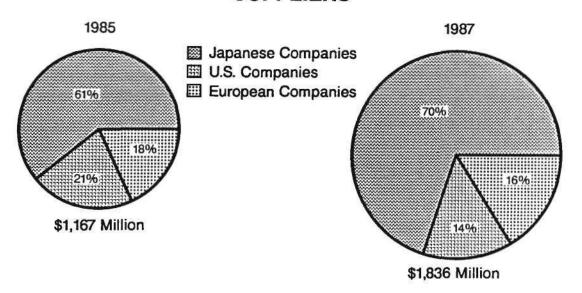
II	111	IV	V	VI
	В	С	N	0
	Al	Si	P.	S
Zn	Ga	Ge	As	Se
Cd	ln	Sn	Sb	Те
Hg	TI	Pb	Bi	Po

SILICON AND EPITAXIAL WAFERS

Agenda

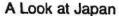
- Merchant wafer supplier sales
- Wafer pricing pressures
- Acquisitions activity
- Outlook on epi

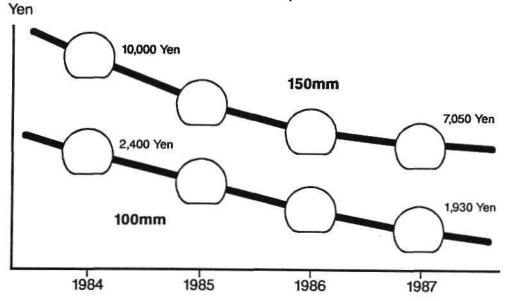
SILICON AND EPITAXIAL WAFER SUPPLIERS



Source: Dataquest

WAFER PRICING PRESSURES





Source: Dataquest

ACQUISITIONS ACTIVITY

Kawasaki Steel	1984	NBK Corporation	CZ
Nippon Kokan K.K.	1985	Great Western Silicon	Poly
Mitsubishi Metal	1986	Siltec Corporation	CZ
Osaka Titanium	1986	U.S. Semiconductor	Ері
???	1988?	Cincinnati Milacron	Ері

Source: Detaquest

OUTLOOK ON EPI

- Merchant epi wafer applications
 - United States

CMOS (memory, logic, ASICs)

Discretè (power devices, microwave)

- Japan

Discrete devices

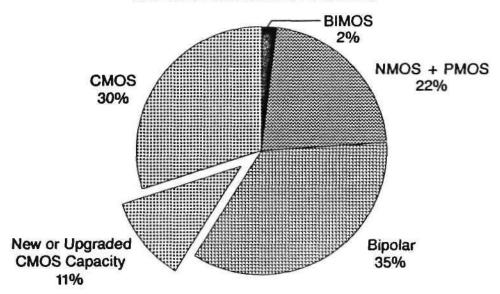
Bipolar ICs

CMOS ICs

- No DRAMs yet
- Epi shortage in 1988?
 - What's driving increased epi demand?

SQUARE INCH CAPACITY BY TECHNOLOGY

1987 North American Fab Data Base



Source: Dataquest

SILICON AND EPITAXIAL WAFER MARKETS "It's Been Tough . . . It's Staying Tough"

Slower Growth Competition

Profitability

Wafer Pricing Pressures

COMPOUND SEMICONDUCTOR MATERIALS

III-V, II-VI, IV-VI

11	tii	IV	V	VI
	В	С	N	0
	Al	Si	P	s
Zn	Ga	Ge	As	Se
Cd	In	Sn	Sb	Te
Hg	Ti	Pb	Bi	Po

COMPOUND SEMICONDUCTORS

Agenda

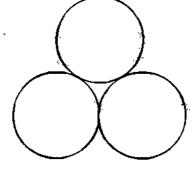
- Devices and applications
- Materials: a potpourri of epitaxial layers
- Deposition technologies

COMPOUND SEMICONDUCTORS

Activity on all Fronts

Semiconductor Manufacturers

Wafer Suppliers



Equipment Companies

COMPOUND SEMICONDUCTORS

Devices

- GaAs ICs
 - Analog: oscillators, amplifiers, MMICs
 - Digital: SRAMs, ASICs, gate arrays
- Optoelectronic devices
 - LED lamps and displays
 - Lasers
 - Photodetectors (avalanche photodiodes)
 - Repeaters
 - Advanced optoelectronic devices
 (i.e., double heterojunction lasers, multiple quantum well lasers, superlattice structures)
- · Other discrete devices
 - Power FETs, small signal transistors

COMPOUND SEMICONDUCTORS

Device Applications

- Communications
 - Fiber optics, satellite communications, local area networks
- · Electronic data processing
 - Supercomputers
- Instrumentation
 - High-speed test and measurement systems
- Military
 - Satellite communications, radar, night vision systems, electronic warfare
- Consumer
 - TV and VCR remote controls, CD players

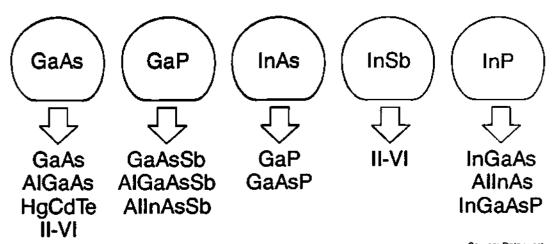
COMPOUND SEMICONDUCTORS

Device Manufacturers: Who is Involved?

North American <u>Companies</u>	European Companies
Avantek	Philips
Gigabit Logic	Plessey III-V
Hewlett-Packard	Siemens
Texas Instruments	Telefunken
TRW	Thomson CSF
	Companies Avantek Gigabit Logic Hewlett-Packard Texas Instruments

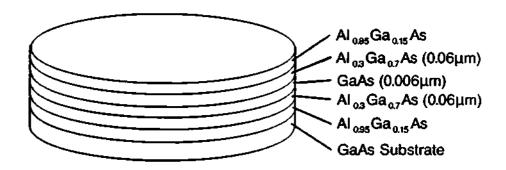
Source: Dataquest

COMPOUND SEMICONDUCTORS III-V SUBSTRATES AND EPITAXIAL LAYERS



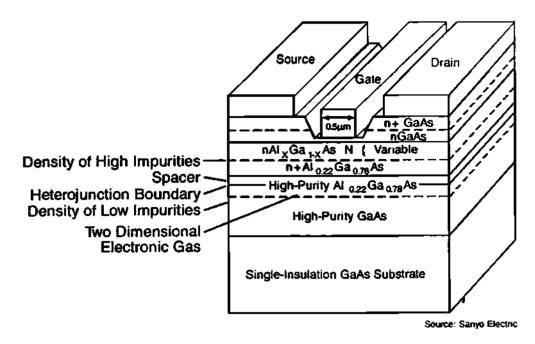
Source: Dataquest

QUANTUM-WELL LASER STRUCTURE



Source: Dataquest

0.5-MICRON GATE HEMT



COMPOUND SEMICONDUCTORS

Wafer Suppliers: Who Is Involved?

- Approximately 40 companies
- North American companies (22)
 - Start-up companies, equipment manufacturers, chemical and mining concerns
- Japanese companies (11)
 - Cable and mining companies, silicon wafer suppliers
- European companies (7)
 - Silicon and materials suppliers, start-up companies

Source: Dataquest

COMPOUND SEMICONDUCTORS

Epitaxial Deposition Technologies

MBE

- Ultrahigh vacuum deposition
- Materials deposited: Compound SC materials, semiconductors, metals, superconductors (?)
- Throughput:
 1-2 wafers/cycle, growth rates of 1-10 A/sec
- Price range: \$600,000-\$1.1 million

MOCVD

- Low-pressure deposition
- Materials deposited:
 Compound SC materials,
 superconductors (?)
- Throughput:
 Higher-throughput systems,
 growth rates of 1-300 A/sec
- Price range: \$200,000-\$570,000

Source: Dataquest

COMPOUND SEMICONDUCTORS

Equipment Companies: Who Is Involved?

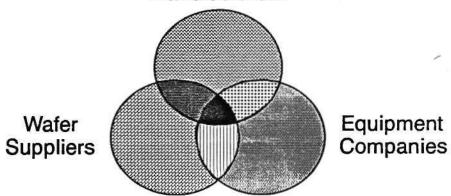
- North American companies
 - MOCVD: Crystal Specialties, Emcore, Spire
 - MBE: Perkin-Elmer, Varian
- Japanese companies
 - MOCVD: Nippon Sanso, TEL Sagami, Ulvac
 - MBE: Anelva, Ulvac
- European companies
 - MOCVD: Cambridge, EEV
 - MBE: ISA Riber, VG Instruments

Source: Dataquest

COMPOUND SEMICONDUCTORS

The Distinctions Are Not So Sharp

Semiconductor Manufacturers



THE BEST OF BOTH WORLDS?

GaAs-on-Silicon

Ш	Ш	IV	V	VI
	В	С	N.	0
	AI	Si	Р	S
Zn	Ga	Ge	As	Se
Cd	ln	Sn	Sb	Te
Hg	TI	Pb	Bi	Po

GaAs-ON-SILICON

- Advantages of silicon
 - Wafer size, cost, mechanical and thermal properties
- · Advantages of gallium arsenide
 - Higher speed, radiation hardness, photonic properties
- Fruits of the marriage?
 - 1K SRAMs (Texas Instruments)
 - Room temperature, continuous-wave laser (University of Illinois, TI, Xerox)
 - Five-year program for development of GaAs-on-Si ICs and focal-plane arrays for radar applications (Ford Microelectronics)

Source: Dataquest

PUTTING IT ALL IN PERSPECTIVE

1987 World Markets at a Glance

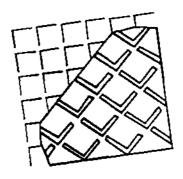
	Silicon-Based	SC Materials
Devices	\$37.4 Billion	\$2.4 Billion
Wafers	\$1,836 Million	\$200 Million +
Epitaxial Equipment	\$53 Million	\$115 Million

Source: Dataquest

Dataquest

BB acompany of The Dun & Bradstreet Corporation

Our Rapidly Changing Industry: Status 1988



COMPETITIVE TECHNOLOGY DEVELOPMENTS IN JAPAN

GENE NORRETT

Corporate Vice President
General Manager, Components Division
Dataquest Incorporated

OVERVIEW - A DAY IN THE LIFE OF A. JOE AMERICA

- 6 a.m. Home automation (HA)
- 7 a.m. Car electronics
- 8 a.m. Office automation (OA)
- 5 p.m. Electronic shopping
- 7 p.m. Home entertainment

Where there is a daily inconvenience, there is a market need.

INVENT THE FUTURE!

6 a.m. - Home Automation



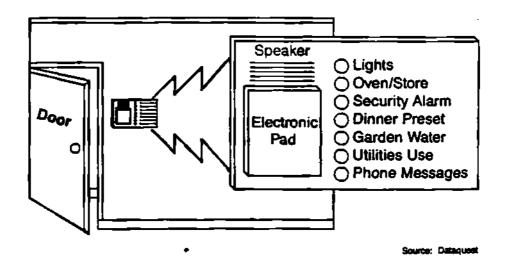
- Wake up
- Shower
- Shave/apply makeup
- Breakfast
- Morning TV
- Home security and controls

HOME AUTOMATION IN THE 1990s

Problems	Needs	Devices Required
Get Kids Up	Stereo wake-up	MCU, DRAM, S/C lasers
Shower Too Hot/Cold	Preset temperature	Sensor, 4-bit MCU
Breakfast Rushed	Preset cooking	4-bit MCU, DRAM
Traffic Jams	Interactive TV/ traffic advisory	16-bit MCU
Forget Lights, Oven, Alarm and Other Items	House control panel at door	Voice-synthesis chips, audio RAM, 8-/16-bit MCUs, sensors

Source: Dataquest

HOME CONTROL SYSTEM OF THE 1990s



7 a.m. - Car Electronics

Problems	Needs	Devices Required
Traffic Jams	Navigation system	Modem ICs, sensors,
		16-/32-bit RISC graphics chips,
		4Mb/16Mb RAM and ROM
Business Calls	Built-in phone/	Modem ICs,
	fax system	16-bit MPUs,
	-	4Mb/16Mb memories

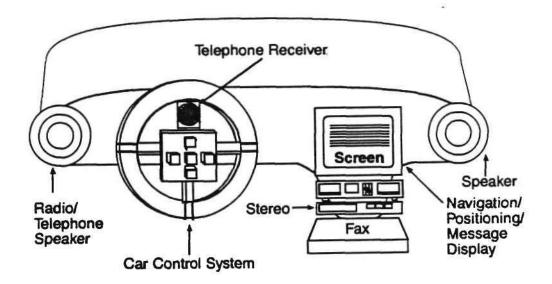
Source: Dataquest

7 a.m. - Car Electronics

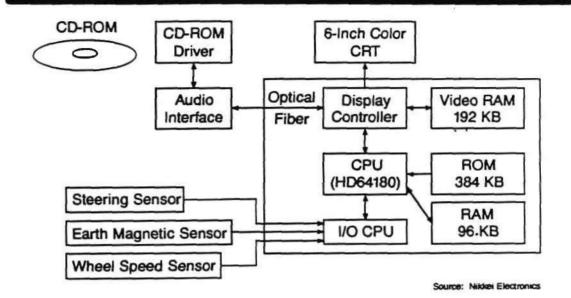
Problems	Needs	Devices Required
Reach for Dials	Built-in steering wheel control system	Voice recognition chips, 16-/32-bit MPUs
Maintenance (Tires, Repairs, Oil)	Maintenance advisory system	4Mb/16Mb ROMs and RAMs 4-bit MCUs
Locked Out	Voice door key	Voice recognition chips

Source: Dataquest

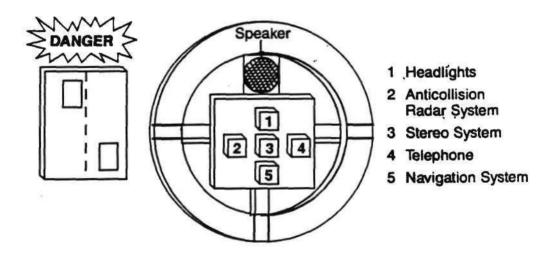
THE AUTOMOTIVE OFFICE OF THE 1990s



TOYOTA'S CD-ROM NAVIGATION SYSTEM



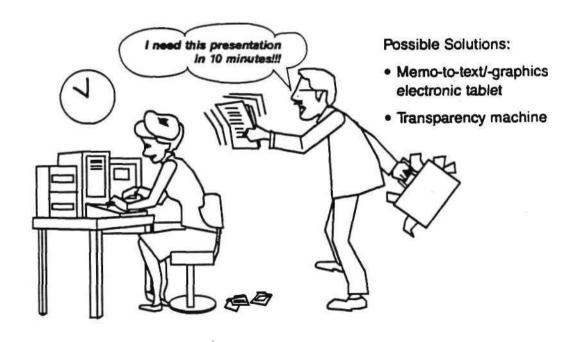
STEERING WHEEL CONTROL SYSTEM



8 a.m. - OFFICE AUTOMATION

Problems	Needs	Devices Required
Phone Tag	Office wrist phone	Modem ICs, DRAMs, MCUs
Copier and Fax Backed Up	Personal, plain paper fax/copier/printer	32-bit MPUs, DRAMs, ROMs, semiconductor lasers
Where Is Person?	Office locator system	Sensors, voice-synthesis ICs
Long Phone Calls	Phone stopwatch and cost calculator	4-bit MCUs, DRAMs
Fax or Phone Cheaper?	Fax/phone alternative cost calculator	MCUs, DRAMs, ROMs
		Source: Dataquest

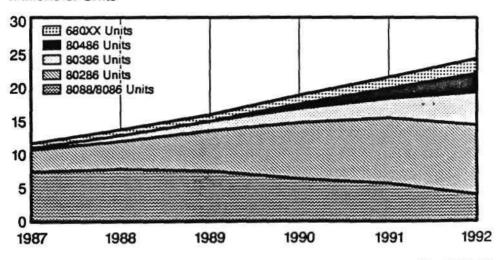
11 a.m. - OFFICE CHAOS



ESTIMATED PC SHIPMENTS

by Microprocessor Type

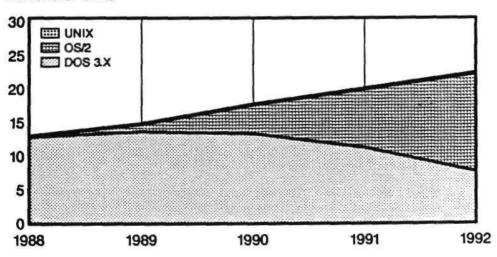
Millions of Units



Source: Dataquest

ESTIMATED PERSONAL COMPUTER OPERATING SYSTEM SHIPMENTS

Millions of Units



Source: Dataquest

VIDEOPHONE PC OF THE 1990s

• 4-8 mips

4-8MB RAM

Megapixel color displays
 8-10 inches

• 3.5-inch storage

Built-in LAN

Coprocessing

80MB hard disk



HOT NEW SEMICONDUCTORS FOR THE OFFICE

Emerging Systems Semiconductors Needed

Laptop PC Sea-of-gates ASICs,

megabit memories (IC cards), specialized 32-bit MPUs, voice recognition chips

Videophone PC CCD sensors,

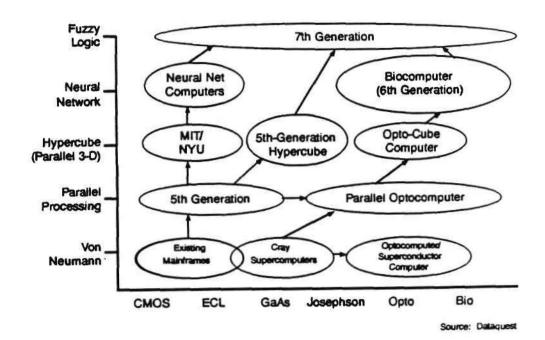
voice recognition chips,

IC card readers

Personal fax/copier Advanced telecom ICs,

printer font ROM cartridges, megabit memory storage

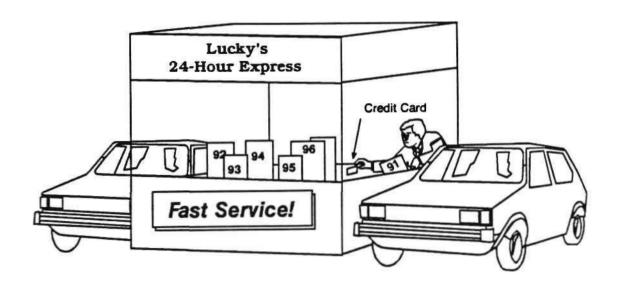
FUTURE COMPUTING TRENDS



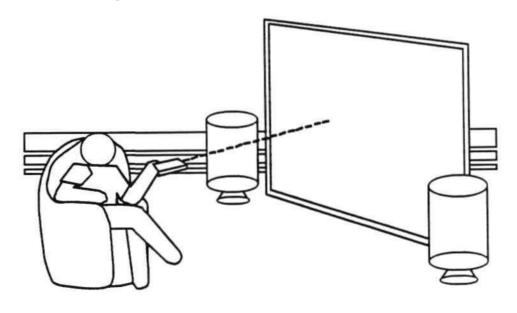
5 p.m. - ELECTRONIC COMPARISON SHOPPING

Item	Lucky's	Safeway	Alpha-Beta
Whole Wheat Bread	\$1.39	\$1.49	\$1.25
1/2-Gallon Skim Milk	2.00	1.80	1.95
Boned Chicken	3.75	4.50	4.25
Raisin Bran Cereal	2.75	3.20	3.10
6-Pack Budweiser	3.50	4.20	3.99
Total	\$13.39	\$15.19	\$14.54
Send Order	Ť		

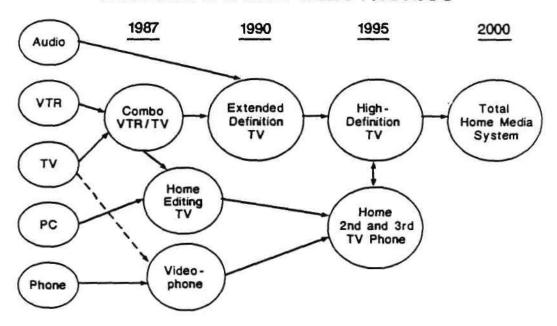
6 p.m. - SHOPPING PICKUP



7 p.m. - HOME ENTERTAINMENT



EMERGING HOME ELECTRONICS

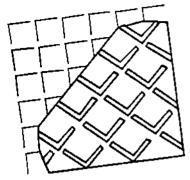


HOT NEW HOME ELECTRONIC SEMICONDUCTORS

Emerging Systems	Semiconductors Needed
Large - Screen	Video RAMs (4Mb/16Mb/64Mb)
Combo VTR/TV	32-bit video processors
	Sea-of-gates ASICs
Remote Control	Semiconductor lasers
Handsets	Voice recognition chips
	32-bit controllers
Videophone Sets	Voice recognition chips
(Second or	Video RAMs
Third TVs)	CCD sensors
**	Specialized 32-bit video processors

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COMPETITIVE STRUCTURE IN ASIA

TOM WANG

Director
Asia/Pacific Components Group
Dataquest Incorporated

AGENDA

- Asian semiconductor industry outlook
- Semiconductor manufacturers in Asia
- Key issues in 1988
- Summary and conclusion

ASIAN SEMICONDUCTOR INDUSTRY OUTLOOK

- Market growing drastically
- Competition increasing significantly
- Manufacturing moving offshore
- Business opportunities growing



SEMICONDUCTOR CONSUMPTION

(Millions of U.S. Dollars)

	1985	1986	1987*
South Korea	\$436	\$624	\$1,101
Taiwan	\$496	\$694	\$1,171
Hong Kong	\$334	\$478	\$ 806
Singapore	\$271	\$350	\$ 590

^{&#}x27; Estimated

Source: Dataquest

ESTIMATED SEMICONDUCTOR CONSUMPTION

(Billions of U.S. Dollars)

	1986	1987	1988	1992
ROW	\$ 2.9	\$ 4.9	\$ 6.3	\$11.8
Europe	\$ 5.5	\$ 6.8	\$ 7.5	\$11.9
Japan	\$12.4	\$14.5	\$17.4	\$27.5
United States	\$10.2	\$12.5	\$14.2	\$20.2

Source: Dataquest

COMPETITION INCREASING SIGNIFICANTLY FROM ASIA



COMPETITION FROM THE 4 "Cs"

- Consumers
- C omputers
- Communications
- Semi-Conductors

SEMICONDUCTOR PRODUCTION

(Millions of U.S. Dollars)

Company	1986	1987*	Growth Rate
Samsung	\$170	\$317	86.5%
GoldStar	\$ 48	\$ 68	41.7%
KEC	\$ 50	\$ 78	56.0%
UMC	\$ 68	\$ 90	32.4%

^{*} Estimated

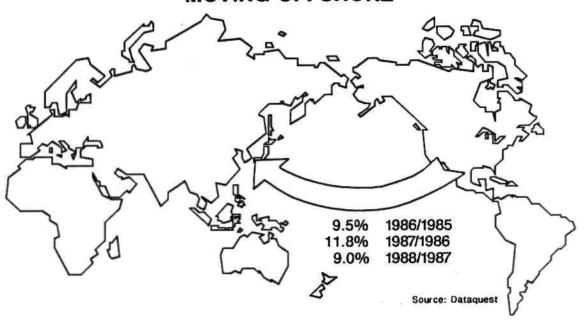
Source: Dataquest

COMPETITION IN MEMORY CHIPS

	Samsung	GoldStar	Hyundai
1M DRAM			
Mass Production	2Q '88	3Q '88	4Q '88
Wafer Size	6"	6"	6"
Design Rule Capacity	1.2µm	1.2µm	1.2µm
(Wafer/Day) 4M DRAM	100-600	600	300
Mass Production	3Q '89	3Q '89	3Q '89

Source: Dataquest

ESTIMATED PERCENT OF U.S. SEMICONDUCTOR CONSUMPTION MOVING OFFSHORE



MAIN REASONS FOR MOVING OFFSHORE

Before:

Low labor cost

Now:

Low labor cost + superior talent +closeness to market

FUNCTIONS OF OFFSHORE FACILITY

Before:

Assembly and testing

Now:

Design + fabrication + assembly and testing

OPPORTUNITY

Economic Growth Real GDP Growth Rates (%)

	1986	1987*	1988
Taiwan	11.0	10.1	7.3
South Korea	12.4	11.1	8.0
Hong Kong	11.0	12.6	8.9
Singapore	1.9	6.9	5.5
China	8.0	9.7	9.1
Japan	2.4	2.5	3.0
United States	2.2	3.1	2.8
Europe	2.5	2.2	2.0

^{*} Estimated

Source: Dataquest

OPPORTUNITY

High-Technology Business Opportunities

- Semiconductor manufacturing
- Semiconductor equipment and materials manufacturing
- Systems manufacturing
- Financial opportunities

SEMICONDUCTOR MANUFACTURERS IN ASIA

SEMICONDUCTOR MANUFACTURERS - SOUTH KOREA

- Samsung
- Goldstar
- Hyundai
- Daewoo
- KEC

SAMSUNG

Sales	\$316 million	Sales Channels	Asia - agents Europe - agents U.S reps/dist'rs. Big OEMers - direct
Products	256K DRAMs - 25% 64K DRAMs - 20% CMOS Logic - 25% Linear ICs - 10% Transistors - 20%	New Products	1M DRAMs 512K EPROMs 256K SRAMs CTV/VTR ICs Codec/Combo
Capacity (Wafers/year)	4" BIP - 360,000 5" MOS - 600,000 6" MOS - 200,000		,

Source: Dataquest

GOLDSTAR

Sales \$69 million Sales Channels Asia - agents Europe - agents TTL - 30% U.S. - reps/dist'rs. **Products** Gate arrays - 20% Big OEMers - direct 74HC/HCT - 10% **New Products** Hybrids - 30% 1M DRAMs

256K DRAMs Linear ICs - 10% 2Kx8 SRAMs 8Kx8 SRAMs 4" BIP - 200,000 Fast TTLs

Source: Dataquest

HYUNDAI

Sales \$40 million Sales Channels Asia - agents

Europe - agents U.S. - reps/dist'rs. Big OEMers - direct

16K SRAMs - 15%

Mask ROMs - 15% MPUs - 10%

256K DRAMs - 50%

5" MOS - 250,000

Others - 10%

New Products 1M DRAMs

Capacity 5" MOS - 120,000 (Wafers/year) 6" MOS - 480,000

Capacity

Products

(Wafers/year)

Source: Dataquest

DAEWOO

Sales \$10 million Sales Channels Asia - agents

Europe - agents

Products Audio ICs - 50%

Custom - 50%

U.S. - reps/dist'rs.
Big OEMers - direct

Capacity 4" BIP - 90,000 New Products ICs for PC

(Wafers/year) ICs for telecom

Source: Dataquest

KEC

Sales	\$78 million	Sales Channels	Domestic - direct International -
Products	Transistors - 70% Linear ICs - 30%		through Toshiba
		New Products	Linear ICs
Capacity (Wafers/year)	4" BIP - 200,000		

Source: Dataquest

SEMICONDUCTOR MANUFACTURERS - TAIWAN

- UMC
- ERSO
- TSMC
- Rectron
- Fine
- Others

UNITED MICROELECTRONICS CORPORATION (UMC)

Sales	\$90 million	Sales Channels	U.S reps./dist'rs.
Rank	50	New Products	PS/2 Model 30 Chip Set SCSI Chips
Products	Microcomponent &		Modern Chip Set
	Memory ICs - 36.7%		Data Communication Chips
	Consumer ICs - 26.3%		
	Telephone ICs - 18.4%		
	Custom ICs - 18.6%		
Capacity	4" MOS - 480,000		
(Waters/Year)	6° MOS - 120,000		
	(Available Nov. 1988)		

Source: Dataquest

ELECTRONICS RESEARCH AND SERVICE ORGANIZATION (ERSO)

Sales

\$30 million

Products

PC Chip Set Consumer ICs Custom ICs Combo

Source: Dataquest

TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY (TSMC)

Product

Foundry

Capacity (Wafers/Year) Fab I - 6" MOS - 120,000 Fab II - 6" CMOS - 360,000 (Available 1989)

Source: Dataquest

SEMICONDUCTOR MANUFACTURERS - HONG KONG

- Hua Ko
- Elcap
- RCL

HUA KO

Products

Consumer ICs

Custom ICs

Capacity (Wafers/Year) 4" MOS - 60,000

Source: Dataquest

ELCAP

Products

EL6116

74HC/HCT Series Consumer ICs Custom ICs

Gate Arrays (up to 3,000 gates)

Packaging Service

Capacity (Wafers/Year)

4" CMOS - 60,000

Source: Dataquest

SEMICONDUCTOR MANUFACTURERS - SINGAPORE

- SGS-Thomson*
- HP
- Chartered

* Only SGS-Thomson is in production now

SGS-THOMSON

Products

EPROMs

Power Transistors

Consumer ICs

Microcomponent ICs

Capacity (Wafers/Year) 5" - 360,000

Source: Dataquest

CHARTERED SEMICONDUCTOR

6" wafer fab will be finished in early 1989.

SEMICONDUCTOR MANUFACTURERS - CHINA

- Wuxi
- BETF
- Beijing Semiconductor Factories #3,
 and 109
- Shanghai #5, 7, 14, and 19 Radio Components Factory
- Li shan
- Others

WUXI MICROELECTRONICS COMPLEX

Products

- Toshiba 5-chip set @ 5 million units/yr.
- Discrete semiconductor components (mostly for consumer electronics applications)
- 64K memories, 4-bit MCUs, and telecom devices in small quantities

WUXI MICROELECTRONICS COMPLEX

Sales channels

 Not well developed, manufacturers almost entirely under exclusive agreement

Trends

- Capable of 3-micron technology
- Most production is of 4-inch wafers
- Future emphasis on telecom ICs, converters, and op amps

KEY ISSUES IN 1988

KEY NEGATIVE ISSUES IN 1988

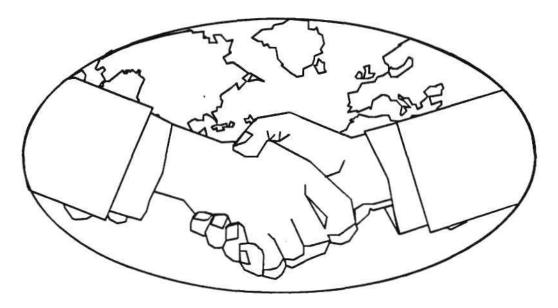
- Currency value appreciation
- Protectionism
- Competition from non-NICs
- U.S.-dependent industry

SUMMARY

- Asian semiconductor industry's worldwide influence will grow
- Asia will be worldwide leader in semiconductor consumption growth
- South Korea will be a significant DRAM producer
- Taiwan will become a major ASIC design center

Source: Dataquest

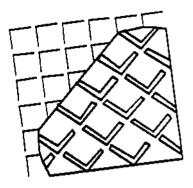
CONCLUSION



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Our Rapidly Changing Industry: Status 1988



EUROPEAN COMPETITIVE ANALYSIS

BIPIN PARMAR

Senior Industry Analyst European Components Group Dataquest UK Limited

WORLDWIDE SEMICONDUCTOR PRODUCERS' SHARES

(Billions of Dollars and Percentages)

	1986		1987		Growth	
Japan	\$14.0	48%	\$17.8	49%	27.2%	
United States	11.6	40	13.9	39	22.4%	
Europe	3.4	11	4.0	11	17.6%	
ROW					50.0%	
· Total	\$29.4	100%	\$36.3	100%	24.5%	

Source: Dataquest

IMPACT OF SEMICONDUCTOR MERGERS

European Market Rankings

<u>1986</u>	<u> 1987</u>	Company	Highest Position
6 and 5	2	SGS-Thomson	Semi 2
7 and 16	6	National-FSC	Bipolar Logic - 2
11 and 21	9	AMD-MMI	Bipolar Memory - 1
15 and 19	13	Plessey-Ferranti	Bipolar GA - 2

- Major impact on bipolar position, not on MOS
- 1988 is year of consolidating manufacturing
- 1989 and '90 new investments in emerging processes

Source: Dataquest

FUTURE TRENDS -EUROPEAN ELECTRONICS INDUSTRY

- Europe will become a unified market after 1992
- Restrictive trade barriers will disappear
- Size of combined market will increase GNP by 5%
- Size of population will be 330 million
- New European standards will emerge in consumer electronics, telecommunications, and computers
- Scale of economy will drive down costs
- Europe will be more competitive in its own market

Source: Dataquest

FUTURE TRENDS -EUROPEAN ELECTRONICS INDUSTRY

- · Europe will have state-of-the-art processing capability
 - Espirit, Eureka, Megaproject
- European community will ensure:
 - Multinationals source components locally
 - Collaborative R&D on all fronts
 - Maintaining strong manufacturing base
- Europe
 - Still strong in consumer electronics and automotive
 - Telecommunications will get stronger
 - Stability in military market

Source: Dataquest

EUROPEAN SEMICONDUCTORS MARKET SHARE

(Billions of U.S. Dollars and Percentages)

	19	986	1:	987	Growth
Japan U.S.	\$0.66 2.53	12.0% . 45.9	\$0.85 2.75	13.3% 43.2	28.8% 8.7%
Europe	2.32	42.0	2.70	42.7	16.4%
ROW	0.02	<u>0.1</u>	0.05	<u>0.8</u>	150.0%
Total	\$5.53	100.0%	\$6.35	100.0%	14.8%

Source: Dataquest

Source: Dataquest

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars ASICs

	<u> 1987</u>	% Market Share
STM ITT	\$ 75.5 73.0	11.3% 10.9%
Siemens AMD-MMI	66.0 44.0	9.8% 6.6%
LSI Logic Mietec	40.0	6.0%
National-Fairchild	32.0 32.0	4.8% 4.8%
Ferranti AMS	28.0 27.0	4.2% 4.0%
Motorola Texas Instruments Others	24.5 24.0 205.1	3.7% 3.6% 30.3%
Total Market	\$671.1	30.3%
י טנמו יאומו אסנ	φυ/ (.)	

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars Bipolar ASICs

	1987	% Market Share
Programmable Logic (Total) AMD-MMI National-Fairchild Philips Texas Instruments	\$65 43 9 8 5	66% 14% 12% 8%
Gate Array (Total) Siemens Ferranti National-Fairchild Motorola Fujitsu Plessey Others	\$76 29 22 6 5 4 4 6	38% 29% 8% 7% 5% 5% 8%
•		(Continued)

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars Bipolar ASICs

	<u>1987</u>	% Market Share
Full Custom (Total)	\$47	
Telefunken	16	34%
Siemens	13	28%
Texas instruments	6	13%
Rifa	4	9%
National-Fairchild	3	6%
Others	5	10%

Source: Dataquest

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars

	1986	1987	Growth 1986-1987	% Market Share 1987
MOS - \$2,647				
intel	201	283	41%	10.7%
Philips	225	258	1%	9.7%
NEC	199	225	13%	8.5%
STM	216	214	(1%)	8.1%
TI	155	184	19%	7.0%
MOS Memory - \$811				
Intel	106	106	0	13.1%
NEC	89	105	19%	12.9%
Hitachi	115	103	(10%)	12.7%
TI	116	102	(12%)	12.6%
Toshiba	56	85	52%	10.5%

Source: Dataquest

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars

	1986	1987	Growth 1986-1987	% Market Share 1987
MOS Micro - \$783				
Intel	100	162	63%	20.7%
NEC	70	94	33%	12.0%
STM	58	74	28%	9.5%
Motorola	59	73	24%	9.3%
Philips	50	55	10%	7.0%
MOS Logic - \$1,053				
Philips	198	199	1%	18.9%
STM	98	90	(8%)	8.5%
lTT	58	89	53%′	8.5%
Motorola	60	71	18%	6.7%
National-Fairchild	47	64	36%	6.1%

Source: Dataquest

EUROPEAN COMPONENTS GROUP

European Market Share Estimates, Millions of U.S. Dollars MOS

	<u>1987</u>	% Market Share
Programmable Logic	\$ 10	
Altera	4	40%
Cypress	2	20%
Xilinx	2	20%
Intel	1	10%
AMD-MMI	1 ,	10%
Gate Array	\$133 [°]	
LSI Logic	36	27%
Plessey	17	13%
National-Fairchild	14	10%
STM	11	8%
Fujitsu	10	8%
Toshiba	10	8%
Others	35	26%

Source: Dataquest

EUROPEAN COMPONENTS GROUP

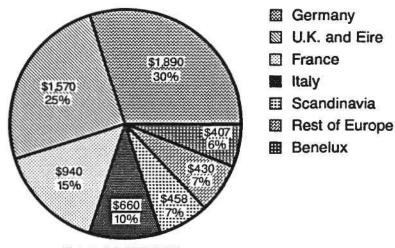
European Market Share Estimates, Millions of U.S. Dollars MOS

	<u> 1987</u>	% Market Share
CBIC	\$ 66	
VLSi Technology	16	24%
AMS	13	20%
Mietec	5	8%
ES2	5	8%
Texas Instruments	4	6%
Others	23	34%
Full Custom	\$275	
iTT	73	27%
STM	61	22%
Mietec	27	10%
ASEA-88	23	8%
Siemens	21	8%
Others	. 70	25%

Source: Dataquest

1987 EUROPEAN SEMICONDUCTOR MARKET BY REGION

(Millions of U.S. Dollars)

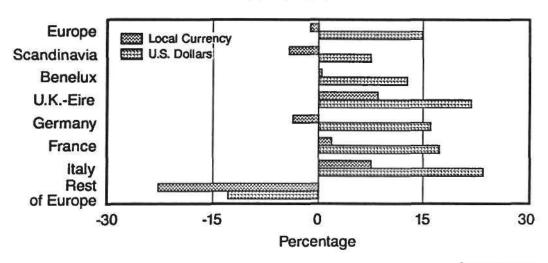


Total: \$6,355 Million

Source: Dataquest

EUROPEAN SEMICONDUCTOR GROWTH BY REGION, IN PERCENTAGES

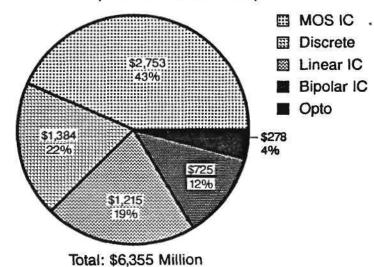
1987 vs. 1986



Source: Dataquest

1987 EUROPEAN SEMICONDUCTOR MARKET BY PRODUCTS

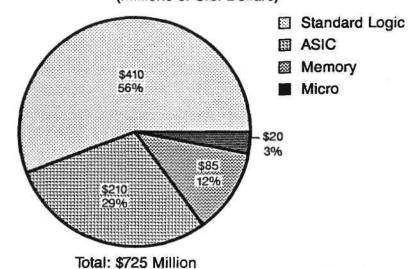
(Millions of U.S. Dollars)



Source: Dataquest

1987 EUROPEAN BIPOLAR MARKET BY PRODUCTS

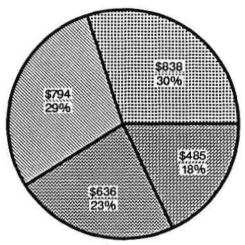
(Millions of U.S. Dollars)



Source: Dataquest

1987 EUROPEAN MOS MARKET BY PRODUCTS

(Millions of U.S. Dollars)



- Micro
- M Standard Logic
- 図 ASIC

Total: \$2,753 Million

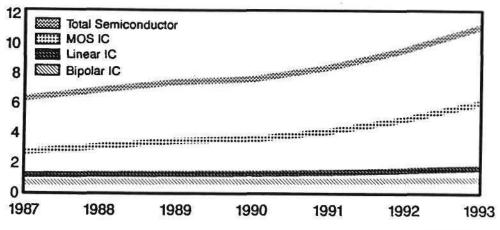
Source: Dataquest

Dataquest Europe SEMICONDUCTOR MARKET FORECAST 1987-1993 April 1988

BIPOLAR, MOS, LINEAR IC EUROPEAN MARKET FORECAST

1987-1993

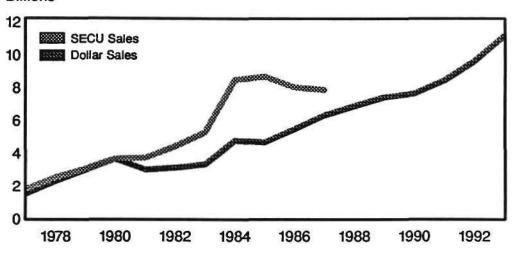
Billions of U.S. Dollars



Source: Dataquest

ESTIMATED EUROPEAN SEMICONDUCTOR SALES IN DOLLARS AND SECUs*/100

Billions

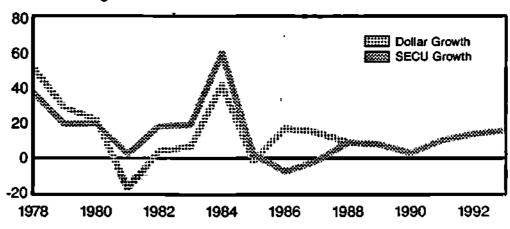


*SECUs = Semiconductor ECUs

Source: Dataquest

ESTIMATED EUROPEAN SEMICONDUCTOR SALES GROWTH IN DOLLARS AND SECUs*

Percent Change

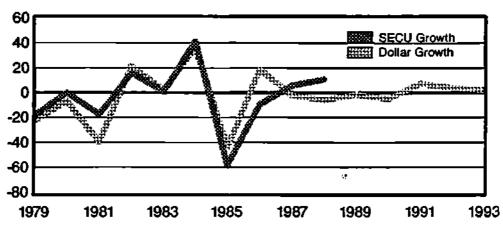


*SECUs = Semiconductor ECUs

Source: Dataquest

ESTIMATED EUROPEAN SEMICONDUCTOR SALES GROWTH DIFFERENTIAL IN DOLLARS AND SECUs*

Percent Differential

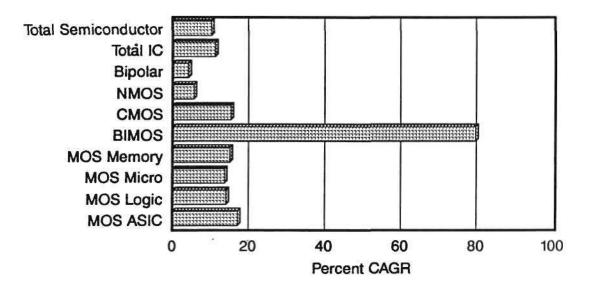


*SECUs = Semiconductor ECUs

Source: Dataquest

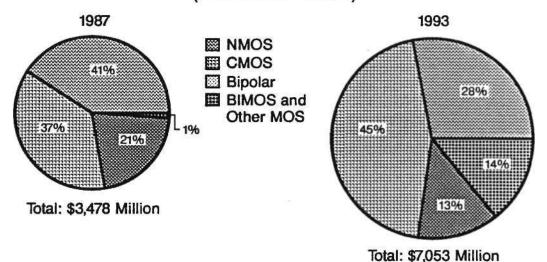
ESTIMATED EUROPEAN SEMICONDUCTOR MARKET

Product CAGR, 1987-1993



ESTIMATED EUROPEAN SEMICONDUCTOR MARKET

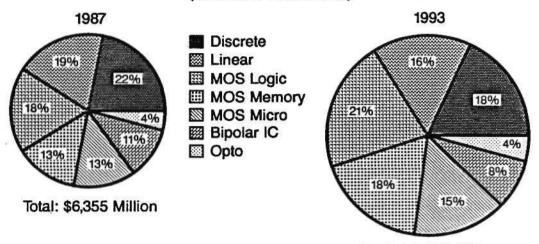
MOS and Bipolar Technology Growth (Millions of U.S. Dollars)



Source: Dataquest

ESTIMATED EUROPEAN SEMICONDUCTOR MARKET

Product Growth (Millions of U.S. Dollars)

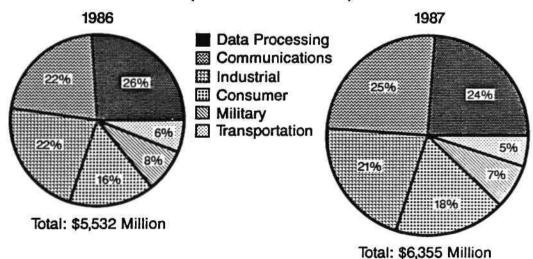


Total: \$11,230 Million

Source: Dataquest

ESTIMATED EUROPEAN SEMICONDUCTOR MARKET

By End Use Segment (Millions of U.S. Dollars)



Source: Dataquest

Dataquest

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